

SIZE	QTY	SYM	PLATED	TOL
0.187	4	+	NO	+/-0.003
0.01	527	X	YES	+/-0.003
0.09528	13	□	YES	+/-0.003
0.03543	36	◇	YES	+/-0.003
0.03937	28	⊗	YES	+/-0.003
0.07	2	⊗	NO	+/-0.003
0.05512	15	+ ^A	YES	+/-0.003
0.006	59	+ ^B	YES	+/-0.003
0.215	6	+ ^C	YES	+/-0.003
0.065	6	+ ^D	YES	+/-0.003

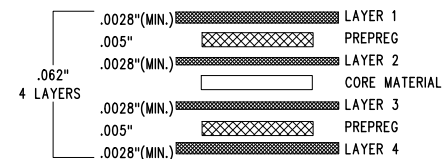
ADDITIONAL REQUIREMENT FOR PROTOTYPE FAB ONLY:

1. OUTGOING INSPECTION REPORT (BASED ON ACTUAL MEASUREMENTS AND CROSS SECTION).

ADDITIONAL REQUIREMENTS FOR PRODUCTION FAB ONLY:

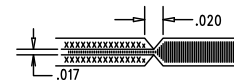
1. PROVIDE COMPLIANCE CERTIFICATES FOR RoHS, REACH AND CONFLICT-FREE MINERALS.
2. SOLDERABILITY BOARD WITH TEST RESULTS.
3. OUTGOING INSPECTION REPORT (BASED ON ACTUAL MEASUREMENTS AND CROSS SECTION).
4. VACUUM PACKED WITH DESICCANT.
5. FULL PANEL WITH NO REJECT

LAYER STRUCTURE



NOTES: UNLESS OTHERWISE SPECIFIED

1. FAB PER IPC-A-600.
2. MATERIAL: -EPOXY FIBERGLASS, NEMA GRADE FR-4
-FINISHED THICKNESS TO BE 0.062" +/- .005"
-TOTAL OF 4 LAYERS WITH 2 OZ. CU ON THE OUTER LAYERS
AND 2 OZ. CU ON THE INNER LAYERS.
-FLAMMABILITY RATING: 94 V-0 MINIMUM.
3. SIZE: CUT TO DIMENSIONS AND TOLERANCES SHOWN.
0.00" ARE PRIMARY DATUMS.
4. DRILLING: -DRILL HOLES PER SCHEDULE. PLATE THROUGH
HOLES WITH COPPER, 0.001" THICK MIN.
-ALL HOLE SIZES ARE SPECIFIED AFTER PLATING.
-HOLE LOCATION TOLERANCES ARE +/-0.003"
IN RELATION TO CENTER
5. FINISH: -SMOBC USING LPI BOTH SIDES, COLOR GREEN.
-GOLD IMMERSION BOTH SIDES.
(LEAD FREE SOLDER CAN BE USED FOR PROTOTYPE)
-FOR SILKSCREEN: BOTH SIDES USE WHITE NON-CONDUCTIVE INK.
6. DO NOT ALTER ARTWORK e.g. TO ADD LOGO OR DATE CODE.
PAD SIZE CAN BE MODIFIED TO MEET END FINISH.
7. PCBs ARE TO BE RoHS COMPLIANT.
8. SCORING FOR PANELIZED PCB:



UNLESS OTHERWISE SPECIFIED			
DIMENSIONS ARE IN INCHES TOLERANCES: 0.XX" = ±0.01" 0.XXX" = ±0.005" INTERPRET DIM AND TOL PER ASME Y14.5M-1994 THIRD ANGLE PROJECTION		TITLE: FABRICATION DRAWING DUAL 6A 20V POLYPHASE MONOLITHIC STEP-DOWN SILENT SWITCHER WITH DIGITAL POWER SYSTEM MANAGEMENT	
SIZE	IC NO.	LT7182SIV	REV
N/A		DC2836A	4
FILENAME:		SHT 1 OF 1	